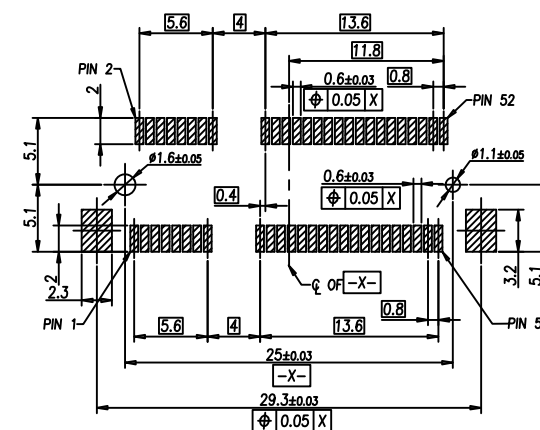
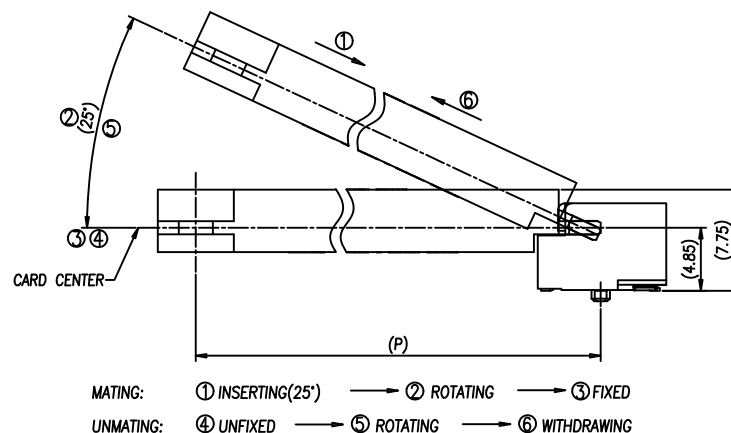
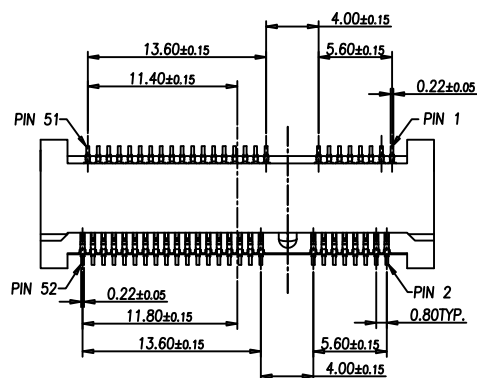


更改 REV	修改内容 MODIFICATION
A	ECXXXX



RECOMMEND PCB LAYOUT(MINIMUM THICKNESS OF THE PCB IS 0.8mm)
(OTHER TOLERANCES ARE NOT MARKED:±0.03)

NOTES:

1.MATERIAL:

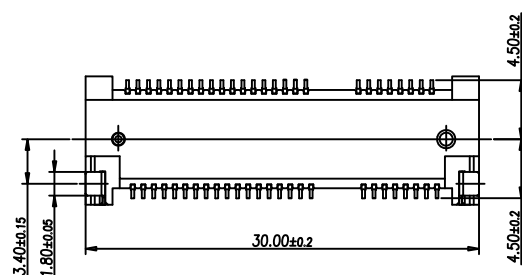
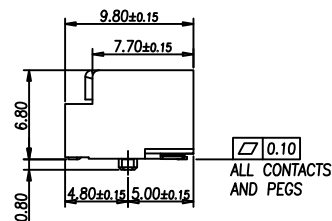
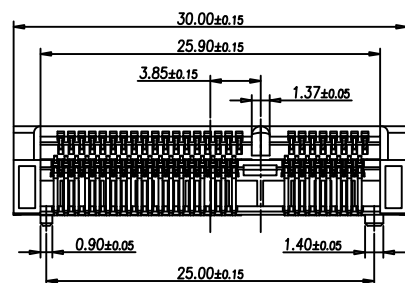
HOUSING: THERMOPLASTIC , BLACK COLOR ,
FLAME RESISTANCE UL94-V0.
CONTACTS: COPPER ALLOY, THICKNESS 0.20mm.
SOLDER PEGS: COPPER ALLOY, THICKNESS 0.2mm.

2.MSL LEVEL:

MSL(MOISTURE SENSITIVITY LEVELS)=1

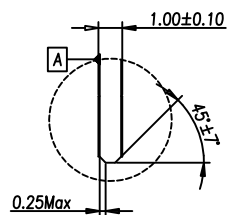
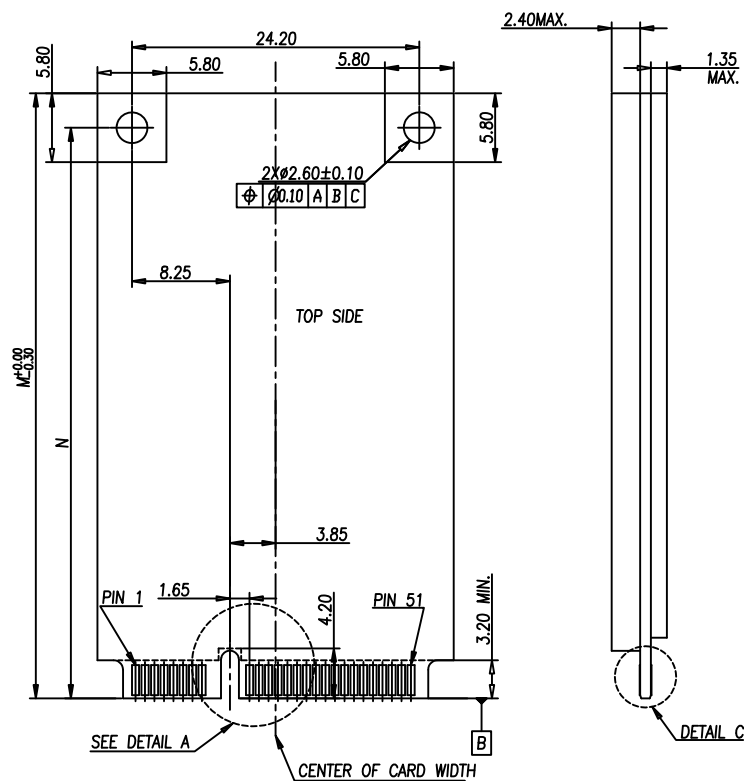
3.FINISHED:

CONTACTS: GOLD PLATING ON CONTACT AREA AND
50~120u" MATTE TIN PLATING ON SOLDER AREA.
30~120u" NICKEL UNDER-PLATING OVER ALL.
SOLDER PEGS: 50~120u" MATTE TIN PLATING OVER 50~120u"
NICKEL UNDER-PLATING OVER ALL.



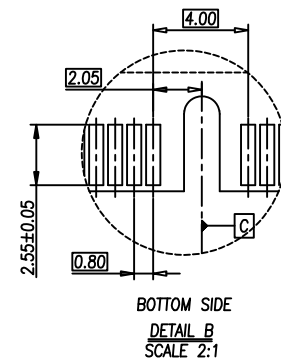
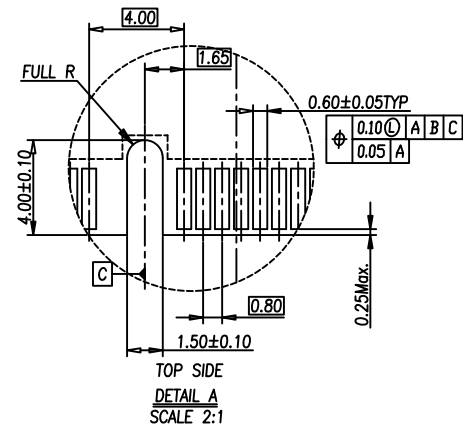
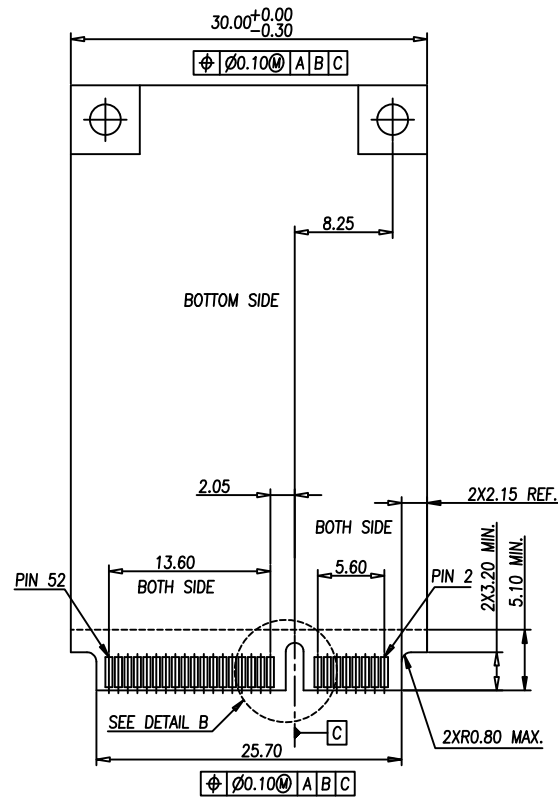
GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X± 0.50	X*± 5 °	名 称(TITLE) MINI PCI EXPRESS H:6.8mm	
.X± 0.30	.X*± 2 °		
.XX± 0.20	.XX*± 1 °		
单 位(UNIT) mm	料 号(PART NO.) 7MPCI-F0-0680	图 号(DWG NO.) 7MPCI-F0-0680	
审 核(APPROVAL)	核 对(CHECKED)	製 图(DRAWN)	比 例 SCALE 1:1 图 数 SHEET 1/1 更 改 REV A

更改 REV	變更內容 MODIFICATION
A	ECXXXX



DETAIL C
SCALE 2:1

	M	N	P
FULL-MINI CARD	50.95	48.05	48.05
HALF-MINI CARD	26.8	23.9	23.9



GENERAL TOLERANCE		KINGCONN 皇海科技股份有限公司	
X ± 0.50	X* $\pm 5^\circ$	名 稱(TITLE) MINI PCI EXPRESS H:6.8mm	
X ± 0.30	X* $\pm 2^\circ$		
XX ± 0.20	XX* $\pm 1^\circ$		
單 位(UNIT) mm	料 號(PART NO.) 7MPCI-F0-0680	圖 號(DWG NO.) 7MPCI-F0-0680	張 數(SHEET) 2/2
審 核(APPROVAL)	核 對(CHECKED)	製 圖(DRAWN)	更 改(REV) A